

ATTY. DKT. NO. AMAT/8670/DSM/LOW K/JW

FORM PTO-1555
(Rev. 6-93)

RECORDATION FORM COVER SHEET

U.S. Department of Commerce
Patent and Trademark Office

OMB No. 0851-0011 (exp. 4/94)

PATENTS ONLY

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original document or copy thereof.

1. Name of conveying party(ies): Date
 LIHUA LI HUANG March 15, 2004
 TZU-FANG HUANG March 15, 2004
 JERRY SUGIARTO (EXECUTOR FOR DECEASED INVENTOR
 DIAN SUGIARTO) September 28, 2004
 LI-QUN XIA March 15, 2004
 PETER WAI-MAN LEE March 15, 2004
 HICHEM M'SAAD March 18, 2004
 ZHENJIANG CUI March 16, 2004
 SOYHUN PARK March 15, 2004

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: See Above and the Attached

2. Name and address of receiving party(ies):

Name: Applied Materials, Inc.Internal Address: P.O. Box 450-A

Street Address: _____

City: Santa Clara State: CA Zip: 95052Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or registration number(s): UNKNOWN

If this document is being filed together with a new application, the execution date of the application is: _____ (Date of Filing)

A. Patent Application No.(s) 10/801,190; Filed March 15, 2004

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Patent CounselInternal Address: APPLIED MATERIALS, INC.Street Address: P.O. Box 450-ACity: Santa Clara State: CA Zip: 950526. Total number of applications and patents involved: 17. Total fee (37 C.F.R. 3.41) _____ \$ 40.00☐ Enclosed☒ Authorized to be charged to deposit account

8. Deposit account number:

50-1074/8670/DSM/LOW K/JW

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Robert W. Mulcahy, Reg. No. 25,436

Name of Person Signing

Signature

Date

10/2/04Total number of pages including cover sheet, attachments and document: 5

Mail documents to be recorded with required cover sheet information to:
 Commissioner of Patents, MAIL STOP PATENT APPLICATION
 P.O. BOX 1450
 Alexandria, VA 22313-1450

PATENT

REEL: 015217 FRAME: 0827

700120311

CH \$40.00 501074 10801190

Atty. Docket No.: AMAT/8670/DSM/LOW K/JW

ASSIGNMENT FOR APPLICATION FOR PATENT

WHEREAS:

Names and Addresses
of Inventors:

1)	LIHUA LI 2866 Parkrow Lane San Jose, California 95132	2)	TZU-FANG HUANG 5431 Ligurian Drive San Jose, California 95138
3)	DIAN SUGIARTO 966 Cascade Drive Sunnyvale, California 94097	4)	LI-QUN XIA 868 Leith Avenue Santa Clara, California 95054
5)	PETER WAI-MAN LEE 1037 Bentoak Lane San Jose, California 95129	6)	HICHEM M'SAAD 3500 Granada Avenue #364 Santa Clara, California 95051
7)	ZHENJIANG CUI 7070 Rainbow Drive #9 San Jose, California 95129	8)	SOHYUN PARK 3770 Flora Vista Avenue, Apt. 2208 Santa Clara, California 95051

(hereinafter referred to as Assignors), have invented a certain invention entitled:

ADHESION IMPROVEMENT FOR LOW K DIELECTRICSfor which application for Letters Patent in the United States was filed on HERewith ,
under Serial No. UNKNOWN , executed on even date herewith; and

WHEREAS, Applied Materials, Inc., a corporation of the State of Delaware, having a place of business at 3050 Bowers Avenue, Santa Clara, California 95054 (hereinafter referred to as Assignee), is desirous of acquiring the entire right, title and interest in and to said application (hereinafter referred to as Application), and the invention disclosed therein (hereinafter referred to as Invention), and in and to all embodiments of the Invention, heretofore conceived, made or discovered by said Assignors, and in and to any and all patents, inventor's certificates and other forms of protection (hereinafter referred to as Patents) thereon granted in any and all countries and groups of countries.

NOW, THEREFORE, in consideration of good and valuable consideration acknowledged by said Assignors to have been received in full from said Assignee:

1. Said Assignors hereby sell, assign, transfer and convey to Assignee the full and exclusive right, title and interest (a) in and to said Application and said Invention; (b) in and to all rights to apply for patents on said Invention in any and all countries pursuant to the International Convention for the Protection of Industrial Property or otherwise; (c) in and to any and all Applications filed and any and all Patents granted on said Invention in any and all countries and groups of countries, including each and every Application filed and each and every Patent granted on any application which is a division, substitution, or continuation of said Application; and (d) in and to each and every reissue or extension of any of said Patents.

2. Said Assignors hereby covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest to said Invention herein conveyed in any and all countries and groups of countries. Such cooperation by said Assignors shall include prompt production of pertinent facts and documents, giving testimony, execution of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for prosecuting any of said applications; (c) for filing and prosecuting substitute, divisional, continuing or additional applications covering said Invention; (d) for filing and prosecuting applications for reissuance of any of said Patents; (e) for interference or other priority proceedings involving said Invention; and (f) for legal proceedings involving said Invention and any application therefore and any Patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Assignors in providing such cooperation shall be paid for by said Assignee.

3. The term and covenants of this agreement shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Assignors, their respective heirs, legal representatives and assigns.

4. Said Assignors hereby warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1) 3/15/04 (DATE)


LIHUA LI HUANG

2) 3/15/04 (DATE)


TZU-FANG HUANG

3) _____ (DATE)

DIAN SUGIARTO

4) 3/15/04 (DATE)


LI-QUN XIA

5) 3/15/04 (DATE)


PETER WAI-MAN LEE

6) 3/18/04 (DATE)


HICHEM M'SAAD

7) 03/16/04 (DATE)


ZHENJIANG CUI

8) 03/15/04 (DATE)


SOHYUN PARK

Atty. Docket No.: AMAT/8670/DSM/LOW K/JW

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WHEREAS:

Names and Addresses
of Inventors:

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IN WITNESS WHEREOF, the said Assignors have executed and delivered this instrument to said Assignee on the dates indicated below.

1)	_____ (DATE)	_____
		LIHUA LI
2)	_____ (DATE)	_____
		TZU-FANG HUANG
3)	<u>9/28/04</u> (DATE)	_____
		DIAN SUGIARTO (Deceased: Executor Jerry Sugianto)
4)	_____ (DATE)	_____
		LI-QUN XIA
5)	_____ (DATE)	_____
		PETER WAI-MAN LEE
6)	_____ (DATE)	_____
		HICHEM M'SAAD
7)	_____ (DATE)	_____
		ZHENJIANG CUI
8)	_____ (DATE)	_____
		SOHYUN PARK